TOSHIBA Field-Effect Transistor Silicon N Channel MOS Type (U-MOSIV)

SSM3K7002BFS

High-Speed Switching Applications Analog Switch Applications

Unit: mm

Small package

• Low ON-resistance : $R_{DS(ON)} = 3.3 \Omega \text{ (max) } (@V_{GS} = 4.5 \text{ V})$

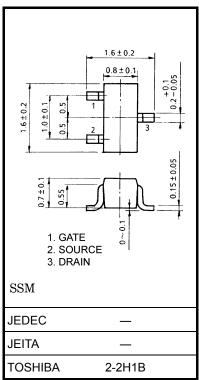
: $R_{DS(ON)} = 2.6 \Omega \text{ (max) } (@V_{GS} = 5 \text{ V})$

: $R_{DS(ON)} = 2.1 \Omega \text{ (max) } (@V_{GS} = 10 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Gate-source voltage		V _{GSS}	± 20	V	
Drain current	DC	ID	200	mA	
	Pulse	I _{DP}	800		
Power dissipation		P _D (Note 1)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



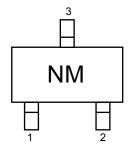
Weight: 2.4 mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

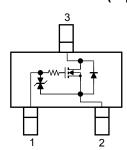
Note 1: mounted on FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{mm}, \text{ Cu Pad: } 0.36 \text{ mm}^2 \times 3)$

Marking



Equivalent Circuit (top view)

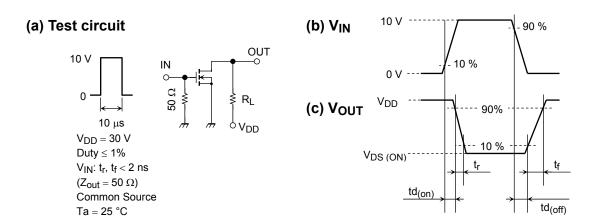


Electrical Characteristics (Ta = 25°C)

Chai	acteristics	Symbol	Test Condition		Min	Тур	Max	Unit
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	± 10	μА
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	= 10 mA, V _{GS} = 0 V		_	_	V
		V (BR) DSX	I _D = 10 mA, V _{GS} = -10 V		45	_	_	
Drain cutoff curre	nt	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V		_	_	1	μΑ
Gate threshold vo	Itage	V _{th}	$V_{DS} = 10 \text{ V}, I_{D} = 0.25 \text{ mA}$		1.5	_	3.1	V
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 200 \text{ mA}$	(Note 2)	225	_	_	mS
Drain-source ON-resistance		R _{DS} (ON)	$I_D = 500 \text{ mA}, V_{GS} = 10 \text{ V}$	(Note 2)	_	1.62	2.1	Ω
			$I_D = 100 \text{ mA}, V_{GS} = 5 \text{ V}$	(Note 2)	_	1.90	2.6	
			$I_D = 100 \text{ mA}, V_{GS} = 4.5 \text{ V}$	(Note 2)	_	2.10	3.3	
Input capacitance		C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz			17.0	_	pF
Reverse transfer capacitance		C _{rss}			_	1.9	_	
Output capacitance		Coss			_	3.6	_	
Switching time	Turn-on delay time	td _(on)	$V_{DD} = 30 \text{ V}$, $I_{D} = 200 \text{ mA}$, $V_{GS} = 0 \text{ to } 10 \text{ V}$			3.3	6.6	
	Turn-off delay time	td _(off)			_	14.5	40	ns
Drain-Source forward voltage		V _{DSF}	I_D = -200 mA, V_{GS} = 0 V	(Note 2)	_	-0.84	-1.2	V

Note2: Pulse test

Switching Time Test Circuit



Precaution

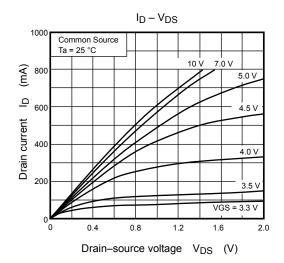
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to be low (0.25 mA for the SSM3K7002BFS). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$. Take this into consideration when using the device.

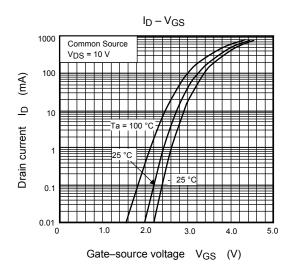
Handling Precaution

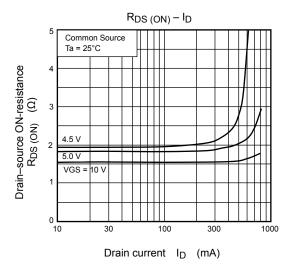
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

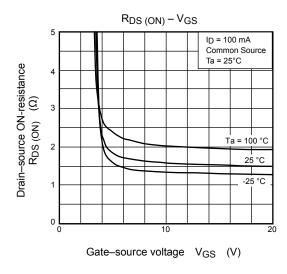
Thermal resistance $R_{th\ (ch-a)}$ and Power dissipation P_D vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

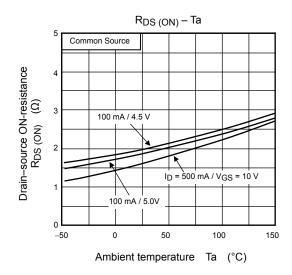
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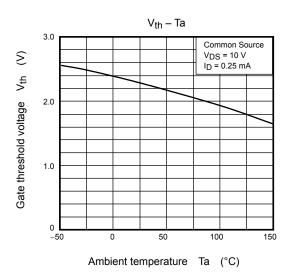




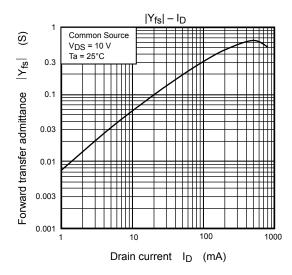


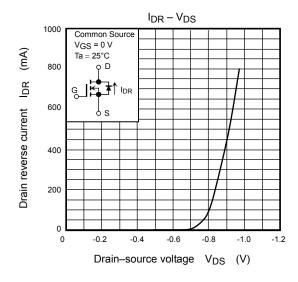


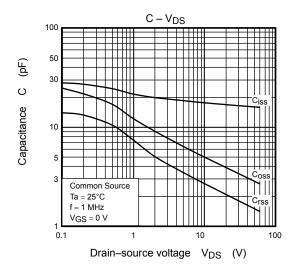


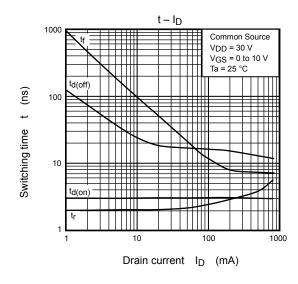


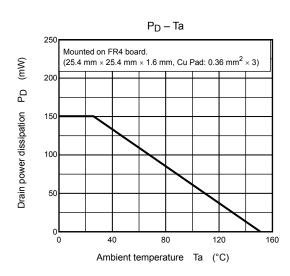
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5